

DMTH69M9LPDWQ 60V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	I _D Tc = +25°С	
60V	12.5mΩ @ VGs = 10V	49	
	16.8mΩ @ V _{GS} = 4.5V	42	

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Wireless charging
- DC-DC converters
- Power managements

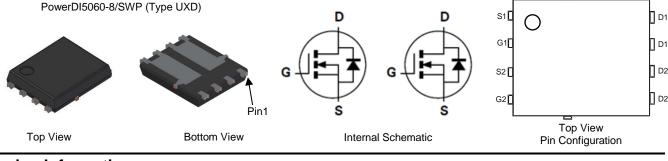
Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low RDS(ON) Minimizes On State Losses
- Low Input Capacitance
 East Switching Capacit
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
 The DMTH69M9LPDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

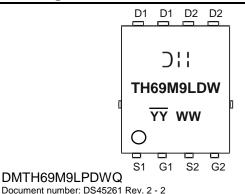
Part Number	Paakaga	Packing		
Fart Nulliber	Package	Qty.	Carrier	
DMTH69M9LPDWQ-13	PowerDI5060-8/SWP (Type UXD)	2500	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds

<1000ppm antimony compounds. 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	60	V	
Gate-Source Voltage	Vgss	±16	V	
Continuous Drain Current, V _{GS} = 10V (Note 6)	T _C = +25°C T _C = +100°C	lD	49 34	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		Ідм	196	A
Maximum Continuous Body Diode Forward Current (Note 6)	ls	48	A	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 19	Ism	196	A	
Avalanche Current, L = 0.1mH	las	32	A	
Avalanche Energy, L = 0.1mH	E _{AS}	51.2	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	54	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	51.7	W
Thermal Resistance, Junction to Case (Note 6)	·	Rejc	2.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

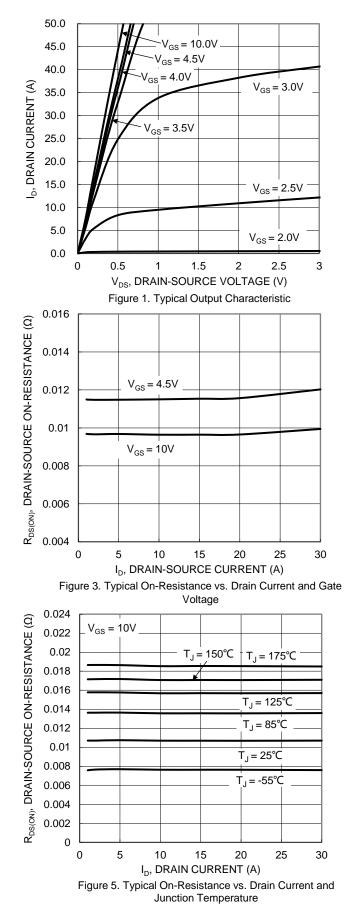
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	V _{GS} = 0V, I _D = 250µA	
Zero Gate Voltage Drain Current	IDSS	_	—	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	-						
Gate Threshold Voltage	VGS(TH)	0.7	—	2	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Deserve	_	10.7	12.5	mΩ	V _{GS} = 10V, I _D = 20A	
	Rds(on)	_	12.4	16.8	11122	V _{GS} = 4.5V, I _D = 15A	
Diode Forward Voltage	V _{SD}	_	0.9	1.2	V	V _{GS} = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)	-						
Input Capacitance	Ciss	—	2178	_		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss		456	—	pF		
Reverse Transfer Capacitance	Crss	—	29.5	_		1 - 1101112	
Gate Resistance	Rg	_	1.7	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 10V)	Qg	_	32	_		V _{DD} = 30V, I _D = 13.5A	
Total Gate Charge (VGS = 4.5V)	Qg		14	_	-0		
Gate-Source Charge	Qgs	_	10	—	nC		
Gate-Drain Charge	Q _{gd}		2.6	_			
Turn-On Delay Time	tD(ON)		6.84	_		$V_{GS} = 10V, V_{DD} = 30V,$ $R_G = 6\Omega, I_D = 13.5A$	
Turn-On Rise Time	t _R		25.7	_	ns		
Turn-Off Delay Time	tD(OFF)	_	51.5	_			
Turn-Off Fall Time	tF	_	38	—	1		
Reverse Recovery Time	t _{RR}	_	42	_	ns		
Reverse Recovery Charge	Q _{RR}	_	70	_	nC	IF = 13.5A, di/dt = 300A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate. Notes:

Borne international of a substance for substance for substance for substance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



DMTH69M9LPDWQ



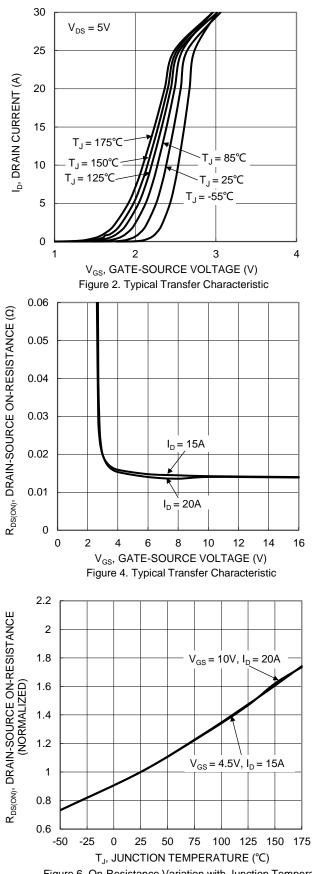
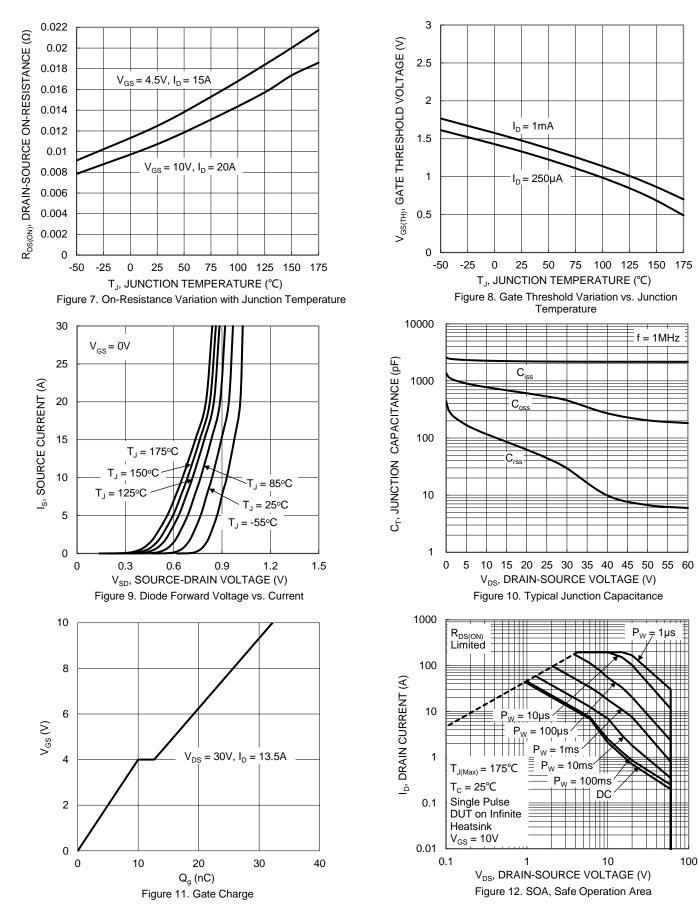


Figure 6. On-Resistance Variation with Junction Temperature

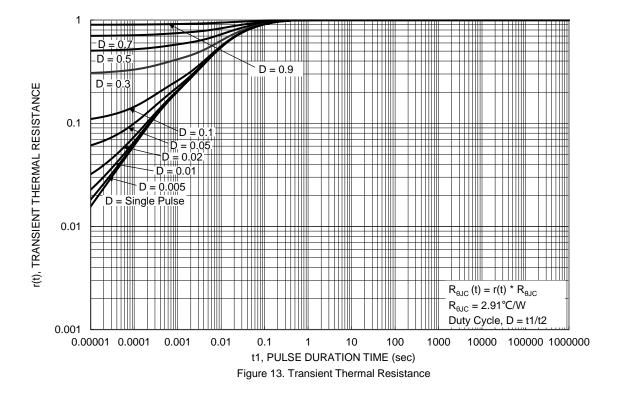


DMTH69M9LPDWQ



DMTH69M9LPDWQ Document number: DS45261 Rev. 2 - 2







PowerDI5060-8/SWP

(Type UXD)

Max

1.10

0.05

0.50

0.35

0.25REF

0.330

5.15 BSC

1.66

4.18

3.86

1.27BSC

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0.835

0.200 0.400 0.300

0.025 0.225 0.125

12

8°

6.40 BSC

4.70 5.10

5.60 6.00

4.195 4.595

0.635 0.835

3.205 4.005

All Dimensions in mm

Тур

1.00

0.41

0.25

0.277

4.90

1.55

3.98

5.80

3.66

4.395

0.735

0.735

3.605

11

7°

Min

0.90

0.00

0.30

0.20

0.230

1.46

3.78

3.46

1.05

0.635

10[°]

6°

Dim

Α

A1

b

b2

b4

С

D

D1

D2

D3

Ε

E1

E2

E2a

e k

L

La

L1

Μ

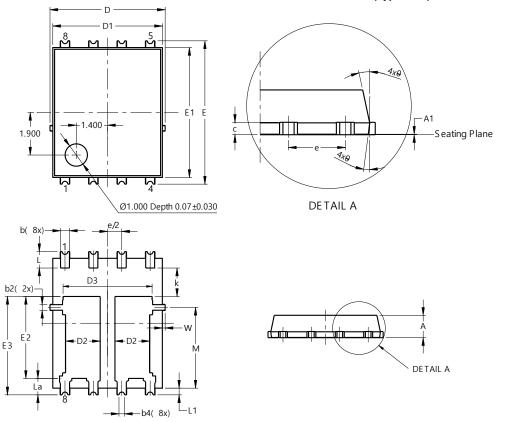
W

θ

θ1

Package Outline Dimensions

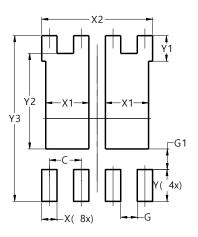
Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI5060-8/SWP (Type UXD)

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI5060-8/SWP (Type UXD)

Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	1.720		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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